

The New **MICROSLICE** Precision Annular Saw.



**LOW DAMAGE, LOW KERF
LOSS, LOW COST**

**HIGH VALUE,
HIGH REPRODUCIBILITY and
PARALLELISM**

MICROSLICE is ideally suited to cutting operations where one or more of the following consideration is important:

- The material to be cut is hard, soft, friable delicate or expensive.
- Cutting loss (kerf) is critical.
- Minimum surface and subsurface damage is essential.
- Flat, ready to polish surfaces are required.

Product Highlights

- Annular blade provides extremely thin cuts.
- Straightness of cut eliminates or reduces lapping time and material loss is minimal.
- Motorized table enables unattended operation.
- Low work damage cutting is ideal for crystals, bones and teeth, geological samples and fragile or crumbly materials.
- Intuitive and easy to use.

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